

# **Quectel Automotive Module**

**Product Overview** 

February, 2020



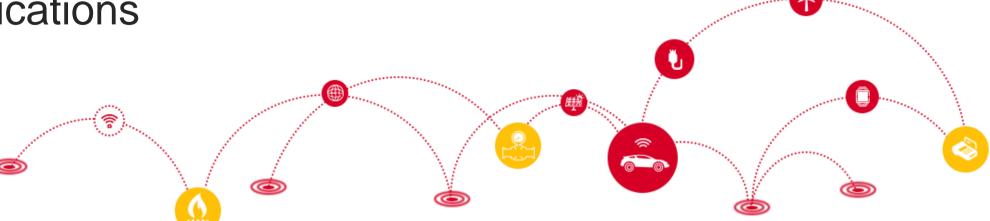
# Roadmap

**Product Overview** 

C-V2X Introduction

**Enhanced Technologies** 

**Applications** 



## **Automotive Modules Roadmap**



LTE Cat 4 AG35 MDM9628



- Automotive Grade
- Multi-mode LTE
- 150M DL/ 50M UL
- GNSS
- CE/-E/-NA/-LA/-J
- LGA Form Factor

*C-V2X* **AG15**MDM9150



- Automotive Grade
- C-V2X PC5
- GNSS
- LGA Form Factor

LTE-A up to Cat 16 C-V2X (Optional) AG520R SA415M



- Automotive Grade
- Multi-mode LTE
- LTE-A up to Cat 16
- Integrate C-V2X Optional
- Multi-Frequency GNSS Optional
- CN/ -NA\*/ -EU\* /-JP \* /-LA\*
- LGA Form Factor

5G C-V2X (Optional) **AG550Q** SA515M



- Automotive Grade
- 5G NR Sub-6G
- 4G/3G/2G fallback
- DSDA Optional
- Integrate C-V2X Optional
- Multi-Frequency GNSS
- CN\*/ -NA\*/ -EU\* /-ROW\*
- LGA Form Factor

C-V2X AP module
AG215S
SA2150P



- Automotive Grade
- Qualcomm SA2150P
- C-V2X SDK integrated
- C-V2X ITS integrated
- HSM integrated

Qx' xx

Estimated Engineering Sample Dates

2017 2018 2019 2020

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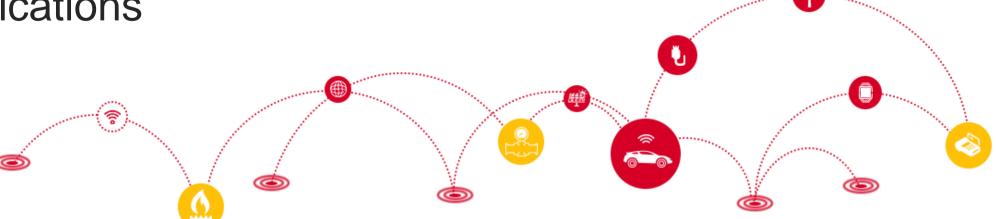
# Roadmap

## **Product Overview**

C-V2X Introduction

**Enhanced Technologies** 

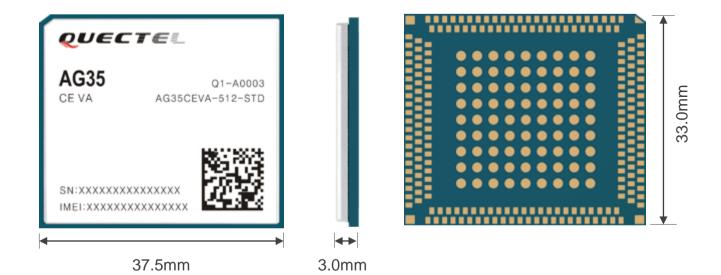
**Applications** 



## Automotive Module AG35 Highlights



Multi-Mode LTE Cat 4 Module (MDM9628)



33.0mm  $\times 37.5$ mm  $\times 3.0$ mm

- Qualcomm MDM9628 chipset solution dedicated for automotive applications
- Ideal for automotive applications with IATF 16949 requirement
- Wide operation temperature range (-40°C to +85°C) and support eCall under +95°C NOTE
- Automotive quality processes (PPAP, 8D, DFMEA, PFMEA...)
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained automotive solutions
- Multi-constellation GNSS receiver available for applications requiring fast and accurate fixes in any environment

NOTE: +95°C eCall application is supported through proper customer system designs, and it may lead to module lifetime shortened.

## **AG35 Specifications**





## ■ Multi-Mode LTE Cat 4 Module 33.0mm × 37.5mm × 3.0mm 150M DL/ 50M UL

Variant		AG35-CE	AG35-E	AG35-NA	AG35-LA	AG35-J
LTE	FDD-LTE	B1/B3/B5/B8	B1/B3/B5/B7/B8/B20/B28	B2/B4/B5/B7/B12(B17)/B13	B1/B2/B3/B4/B5/B7/B8/ B28	B1/B3/B5/B8/B9/B19/ B21/B28
	TDD-LTE	B34/B38/B39/B40/B41	B38/B40	\	\	B41
LIMTS	WCDMA	B1/B8	B1/B5/B8	B2/B4/B5	B1/B2/B3/B4/B5/B8	B1/B3/B5/B6/B8/B19
UMTS	TD-SCDMA	B34/B39	1	\		\
EVDO/CD	MA	BC0 <sup>1</sup>	1	\	\	\
GSM		900/1800MHz	900/1800MHz	850/1900MHz	850/900/1800/1900MHz	\
Embedde	d GNSS	Υ	Υ	Υ	Υ	Υ
Dead Rec	koning	Optional	Optional	Optional	Optional	Optional
PPE (RTK	()	Optional	1	\	1	1
Wi-Fi/BT	Interface	Υ	Υ	Υ	Υ	Υ
Region		China	EMEA, Korea, Australia, India, Southeast Asia	North America	Latin America	Japan
Certificat	Certification	Regulatory: SRRC/ NAL/ CCC	Carrier: KT*/ STK*/ LGU+* Regulatory: GCF/ CE/ FCC/ KC/ RCM	Carrier: AT&T/ Rogers/ Verizon*/ T-Mobile* Regulatory: GCF/ FCC/ PTCRB/ IC	Regulatory: CE/ FCC/ Anatel/ RCM	Carrier: NTT DOCOMO* Regulatory: JATE/ TELEC

<sup>&</sup>quot;Y" means supported.

## AG35 Key Features



Item	Description
	Enhanced processes compliant with the key testing items required by AEC-Q100
Chipset	Application processor  - ARM Cortex A7 up to 1.2 GHz with 256kB L2 cache  - ARM Cortex A7 - primary boot processor  Modem processor  - QDSP6 processor at up to 691MHz (Turbo)  RPM processor  - ARM Cortex M3 up to 100 MHz
Memory	Embedded Nand+DDRAM - NAND: 512MB - DDRAM: 256MB Available for customers - NAND: > 120MB - DDRAM: > 100MB
Interfaces	USB 2.0, HSIC, UART, I2C, PCM, SGMII, SDIO, (U)SIM, ADC, SPI, GPIOs
Enhanced Features	Wi-Fi + BT* eCall, QuecOpen® (Open Linux), Multi-APN ERA-GLONASS* Secure Boot, TrustZone/TPM*, Code/user data backup for higher security Temperature management Embedded codec (Optional) ESD/ EMI protection through internal specific circuits and components
	LTE: LTE-FDD: Max 150 Mbps (DL), Max 50 Mbps (UL) LTE-TDD: Max 130 Mbps (DL), Max 30 Mbps (UL)
	UMTS: DC-HSDPA: Max 42 Mbps HSUPA: Max 5.76 Mbps WCDMA: Max 384Kbps (DL/UL)
Data Speed	TD-SCDMA: Max 4.2 Mbps (DL), Max 2.2 Mbps (UL)
	<b>CDMA2000:</b> EVDO: Max 3.1 Mbps (DL), Max 1.8 Mbps (UL) 1X Advanced: Max 307.2Kbps (DL/UL)
	<b>GSM:</b> EDGE: Max 296Kbps (DL), Max 236.8Kbps (UL) GPRS: Max 107Kbps (DL), Max 85.6Kbps (UL)

## **AG35-CE Timeline**



2018

#### **Project Stage**



#### **Regulatory Certifications**

SRRC/ NAL/ CCC



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Rev.: V2.6 | Status: Released

## AG35-E Timeline



2019						2020											
Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.

#### **Project Stage**



#### **Carrier Certification Schedule**

KT/ SKT/ LGU+ TBD TBD

#### **Regulatory Certifications**

GCF/ CE/ FCC/ KC/ RCM Completed

### AG35-NA Timeline



	2019										2020			
Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.

#### **Project Stage**



#### **Carrier Certification Schedule**



#### **Regulatory Certifications**

GCF/ FCC/ PTCRB/ IC Completed

## AG35-LA Timeline



	2018								2019							2020
O	ct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.

#### **Project Stage**





#### **Regulatory Certifications**

**CE/ FCC/ Anatel/ RCM** 







## AG35-J Timeline



	2019										2020						
Ja	n.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May

### **Project Stage**



#### **Carrier Certification Schedule**

NTT DOCOMO

Start

Complete (Planned)

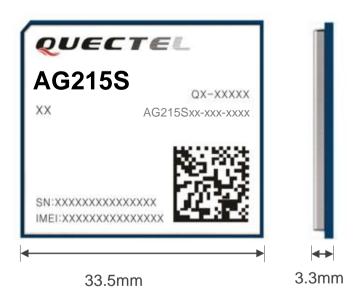
#### **Regulatory Certifications**

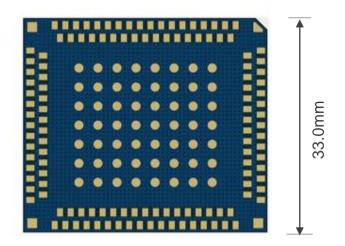
JATE/ TELEC Completed

## Automotive EAP Module AG215S Highlights



AP Module Dedicated for C-V2X (SA2150P)



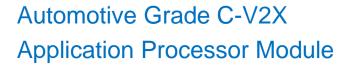


33.0mm  $\times 33.5$ mm  $\times 3.3$ mm

- Qualcomm SA2150P chipset dedicated for the C-V2X Application Processor
- Automotive quality processes (PPAP, 8D, DFMEA, PFMEA...)
- IATF 16949 compliant Application Processor to host ITS stack and applications
- Optimized communication performance with Quectel AG520R/AG550Q
- Hardware Crypto Engine embedded to fulfill powerful ECDSA verification capability
- Support global and China national security algorithms
- Additional HSM/SE integrated, and optional ITS stack integrated
- Wide operation temperature range (-40°C to +85°C)
- Extremely high reliability thanks to automotive grade testing standard

## C-V2X AP Module AG215S Specifications





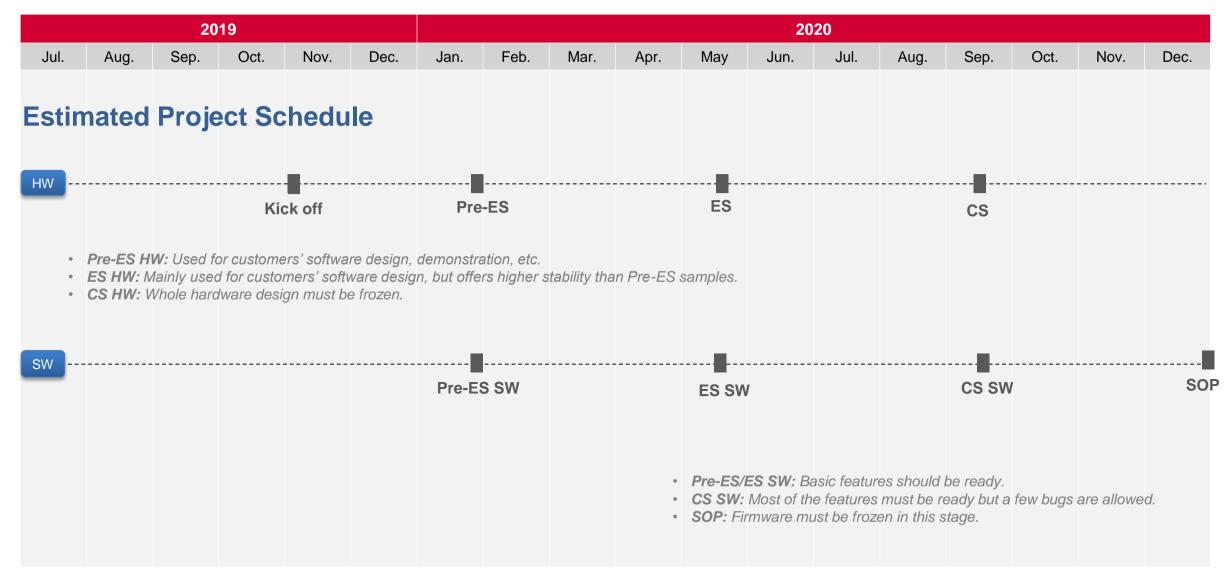


33.0mm  $\times$  33.5mm  $\times$  3.3mm

Features	AG215S
Processors	<ul> <li>64-bit ARM Cortex-A53 Microprocessor Cores</li> <li>1.4 GHz Dual-Core Processor (Quad-Core Processor Optional)</li> </ul>
Interfaces	PCIe Gen2, USB 3.0/2.0, RGMII 1 Gbps, UART, SPI, I2C, 1PPS (Input), ADC
Embedded ECDSA Hardware Engine	Support NIST p-384, NIST p-256, Brainpool p-384, Brainpool p-256, SM2 256 bit Curves
Scalable ECDSA Capability	Up to 2500TPS through embedded engine and CPU (based on NIST p-256 and SM2)
Hardware Crypto Engine Embedded	<ul> <li>Secret key generation and storage, and digital signature and verification</li> <li>Additional 2000TPS ECSDA capability (based on NIST p-256 and SM2)</li> </ul>
Region	Global
Certification	TBD

## AG215S EAP Module Timeline (Estimated)

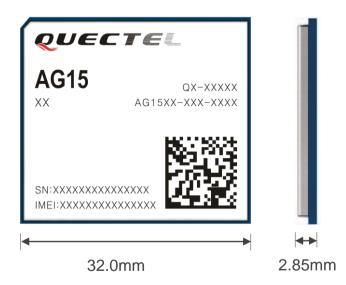


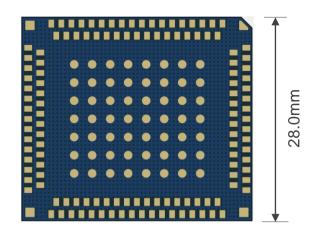


## Automotive C-V2X Module AG15 Highlights



Support C-V2X PC5 Direct Communications (MDM9150)





 $28.0 \text{mm} \times 32.0 \text{mm} \times 2.85 \text{mm}$ 

- Qualcomm MDM9150 chipset solution dedicated for C-V2X (V2V, V2I, V2P) applications
- Designed to meet IATF 16949 requirements
- Wide operation temperature range (-40°C to +85°C)
- Automotive quality processes (PPAP, 8D, DFMEA, PFMEA...)
- Extremely high reliability thanks to automotive grade testing standard
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained automotive solutions
- Multi-constellation GNSS receiver available for applications requiring fast and accurate fixes in any environment

## C-V2X Module AG15 Specifications



Qualcomm MDM9150 C-V2X Chipset solution based on 3GPP Rel.14 for PC5-based direct communications

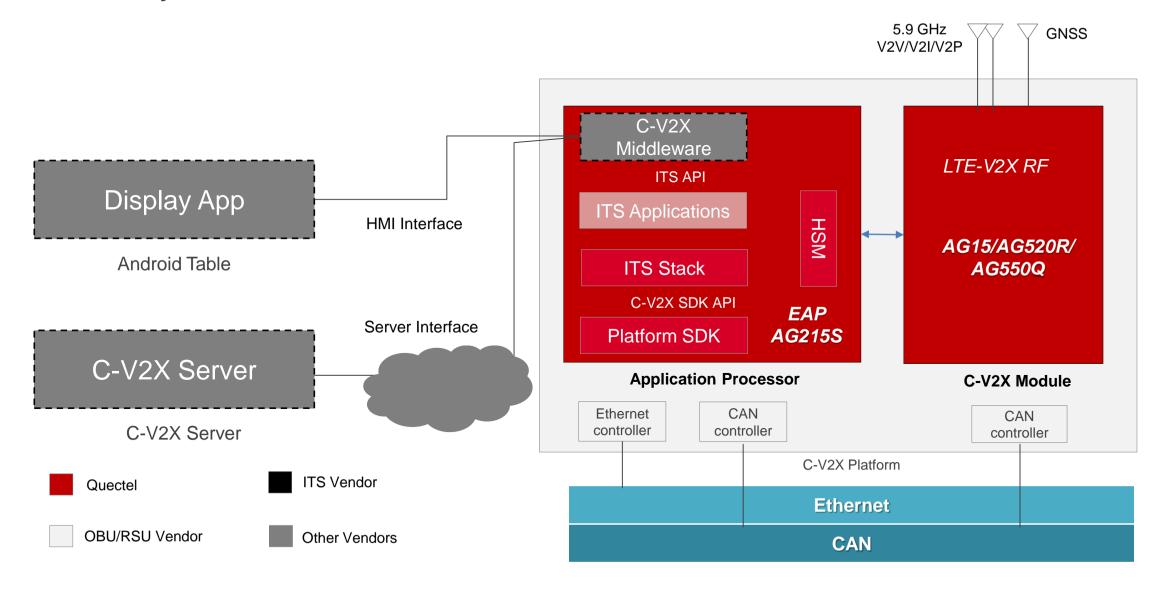


28.0mm  $\times$  32.0mm  $\times$  2.85mm

Features	AG15
Frequency	5.8GHz & 5.9GHz
Embedded GNSS	GPS, GLONASS, BeiDou, Galileo, QZSS
Interfaces	PCIe, USB 3.0/2.0, SPI, I2C, UART, GPIO, ADC, DR_SYNC
Dead Reckoning	QDR3 (Share the same IMU with MDM9628)
Enhanced Features	PACE (Position Assisted Clock Estimator), TUNC (Time Uncertainty Constraint)
Region	Global
Certification	TBD

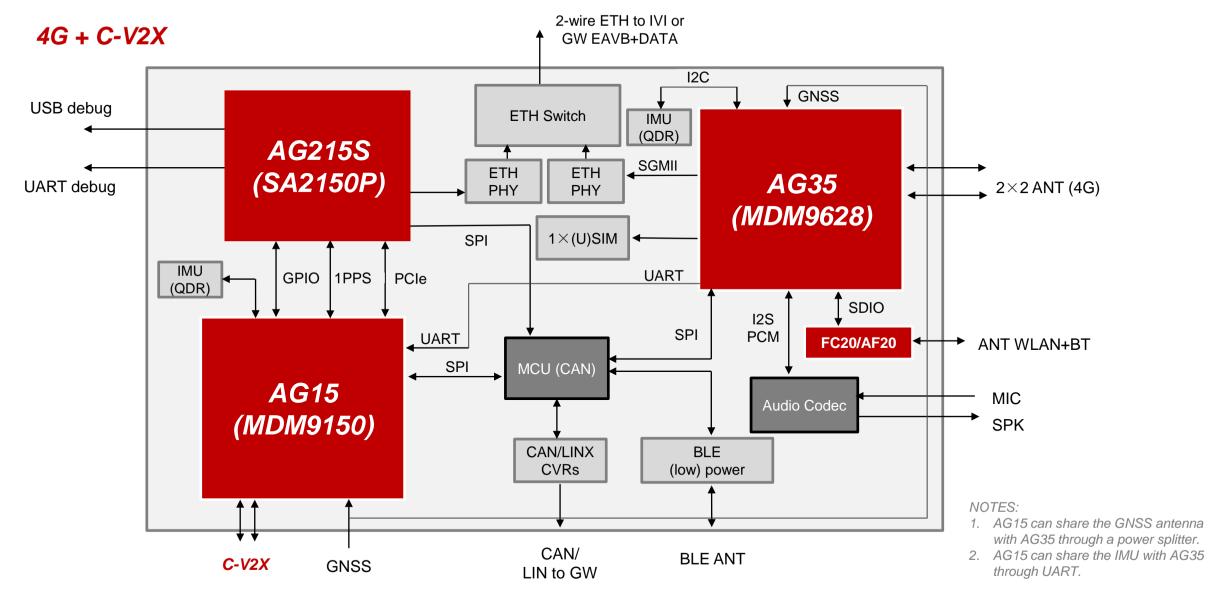
## C-V2X System Architecture





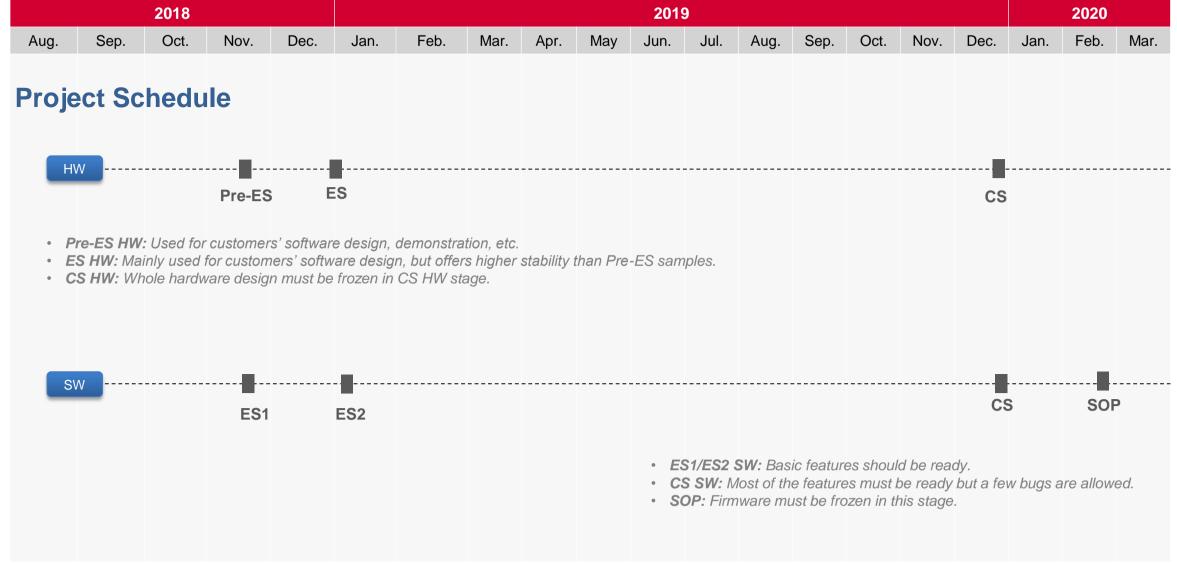
### AG15+AG35+AG215S TCU Hardware Architecture





### AG15 Timeline





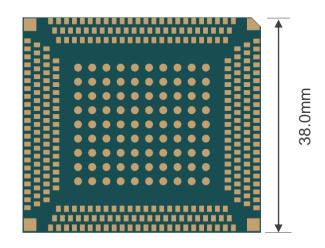
## Automotive Module AG520R Highlights



Multi-Mode Automotive Module up to LTE Cat 16 + Optional C-V2X (SA415M)







 $38.0 \text{mm} \times 42.0 \text{mm} \times 2.85 \text{mm}$ 

- AEC-Q100 qualified Qualcomm SA415M chipset solution dedicated for automotive and optional C-V2X applications
- Ideal for automotive applications with IATF 16949 requirement
- Wide operation temperature range (-40°C to +85°C) and support eCall under +95°C
- Automotive quality processes (PPAP, 8D, DFMEA, PFMEA...)
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained automotive solutions
- Multi-frequency GNSS receiver available for applications requiring fast and accurate fixes in any environment

## AG520R Specifications



#### ■ Multi-Mode LTE up to Cat 16 + Optional C-V2X

Variant		AG520R-CN	AG520R-EU*	AG520R-NA*	AG520R-JP*	AG520R-LA*
LTE	FDD-LTE	B1/B3/B5/B7/B8	B1/B3/B5/B7/B8/B20/B28/B32	B2/B4/B5/B7/B12/B13/B14/B17/ B25/B26/B29/B30/B66/B71	B1/B3/B5/B8/B9/B11/B18/ B19/B21/B28	B1/B2/B3/B4/B5/B7/B8/ B20/B28
	TDD-LTE	B34/B38/B39/B40/B41	B38/B40/B41	\	B41	B38/B40/B41
UMTS	WCDMA	B1/B8	B1/B3/B5/B8	B2/B4/B5	B1/B3/B5/B8/B9/B19	B1/B2/B3/B5/B8
OWITS	TD-SCDMA	\	\	\	\	\
GSM		900/1800MHz	900/1800MHz	\	\	850/900/1800/1900MHz
C-V2X Option	onal	B47	B47	B47	TBD	B47
MF-GNSS	Optional	L1+L5	L1+L5	L1+L5	L1+L5	L1+L5
Dead Reck	koning <sup>Optional</sup>	QDR 3.0	QDR 3.0	QDR 3.0	QDR 3.0	QDR 3.0
PPE (RTK)	)	Optional	Planning	Planning	TBD	\
Ethernet <sup>O</sup>	Optional	RGMII	RGMII	RGMII	RGMII	RGMII
Wi-Fi/BT Ir	nterface	Υ	Υ	Υ	Υ	Υ
Region		China	EMEA, Korea, Brazil, India, Australia	North America	Japan	Latin America
Certification	on	TBD	TBD	TBD	TBD	TBD

<sup>&</sup>quot;Y" means supported.

<sup>\*</sup> means under development. Rev.: V2.6 | Status: Released

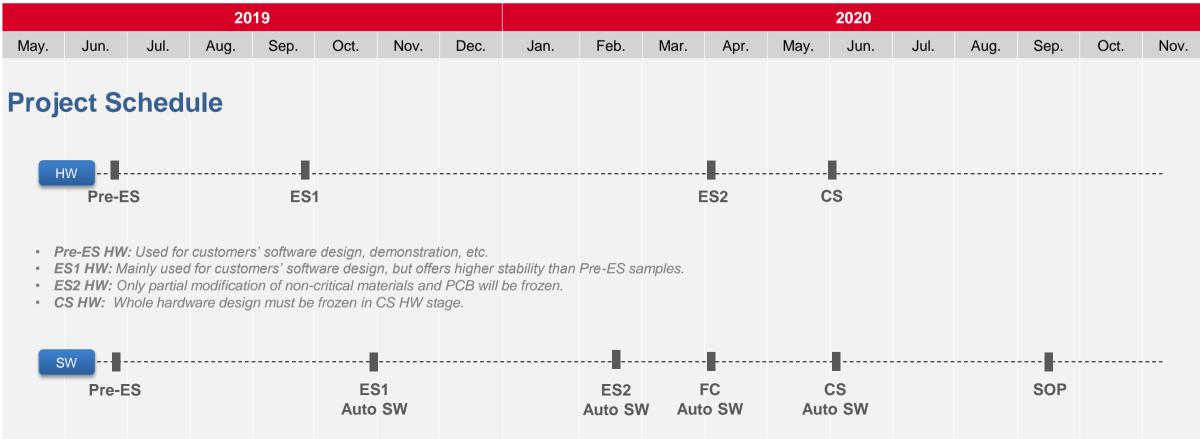
# AG520R Key Features



Item	Description	1									
4G Category	Max up to C	ax up to Cat 16									
Apps Processor	ARM Cortex	M Cortex A7 at 1.5GHz; 256 KB L2									
C-V2X Optional	PC5 Mode 4	5 Mode 4 (direct communication), uu mode									
Embedded GNSS		PS/ GLONASS/ BeiDou/ Galileo  hanced Automotive MF-GNSS (L1+L5) Optional									
QDR Optional	QDR3 (exte	QDR3 (external IMU is required)									
Interface	PCIe, USB 2	PCIe, USB 2.0/3.0, RGMII, SDIO, SPI, I2C, I2S, PCM, UARTs, GPIOs, 1PPS, Wi-Fi interface, BT interface									
Antenna Interfaces	<ul> <li>2 × C-V2</li> </ul>	antenna interfaces for LTE Cat 16 ( $4\times4$ MIMC $2\times4$ Antenna interfaces $6\times4$ S antenna interface	MO)								
	LTE:	LTE-FDD: Max 1 Gbps (DL), Max 75 Mbps (	(UL) LTE-TDD: Max 880 Mbps (DL), Max 45 Mbps (UL)								
Data Spand	UMTS:	DC-HSDPA: Max 42 Mbps HSUPA: Ma	Max 5.76 Mbps WCDMA: Max 384Kbps (DL/UL)								
Data Speed	GSM:	EDGE: Max 296Kbps (DL), Max 236.8Kbps (	GPRS: Max 107Kbps (DL), Max 85.6Kbps (UL)								
	C-V2X:	Tx: Max 30 Mbps, Rx Max 30 Mbps									

#### AG520R-CN Timeline

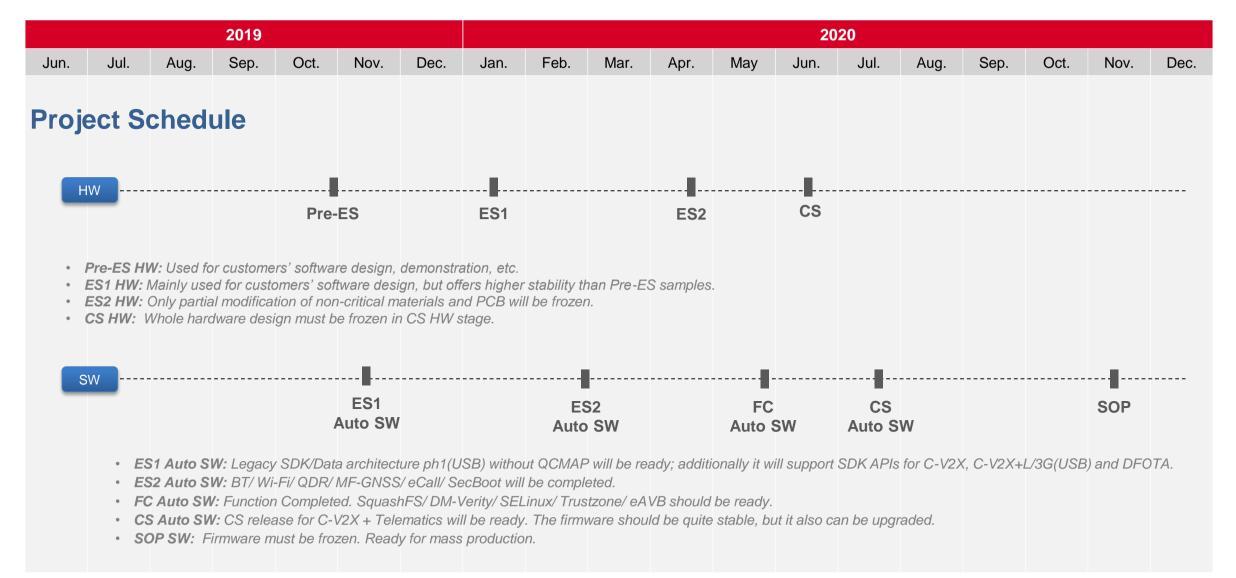




- Pre-ES SW: Auto baseline. Some basic functions must be ready. Mainly used for customers' initial software development.
- ES1 Auto SW: Legacy SDK/Data architecture ph1(USB) without QCMAP will be ready; additionally it will support SDK APIs for C-V2X, C-V2X+L/3G(USB) and DFOTA.
- ES2 Auto SW: BT/ Wi-Fi/ QDR/ MF-GNSS/ eCall/ SecBoot will be completed.
- FC Auto SW: Function Completed. SquashFS/ DM-Verity/ SELinux/ Trustzone/ eAVB should be ready.
- CS Auto SW: CS release for C-V2X + Telematics will be ready. The firmware should be quite stable, but it also can be upgraded.
- **SOP SW:** Firmware must be frozen. Ready for mass production.

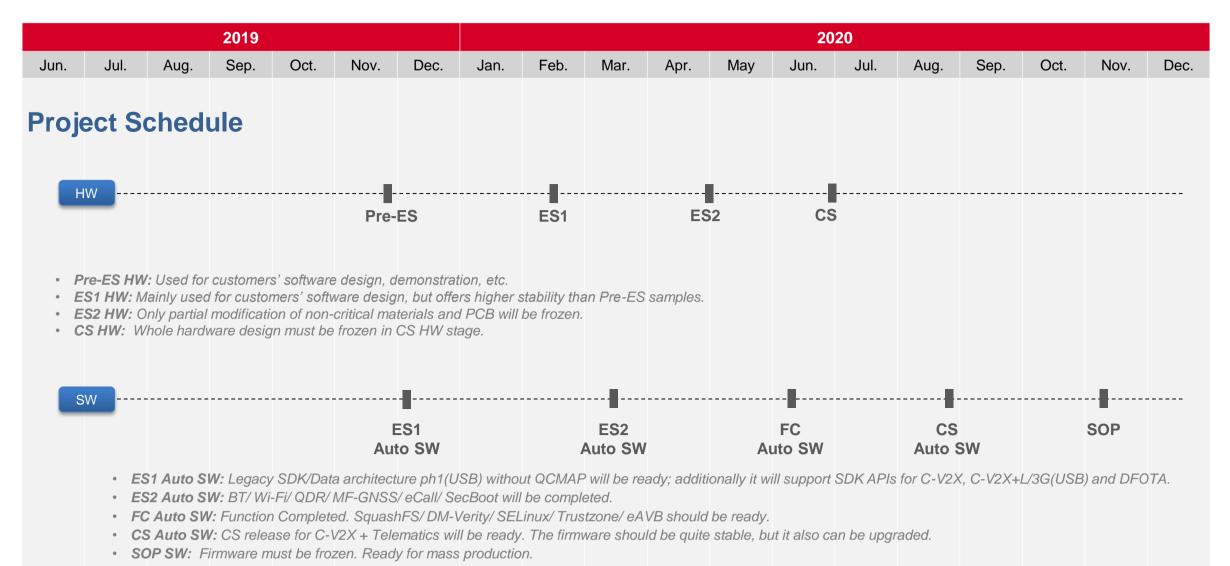
#### AG520R-EU Timeline





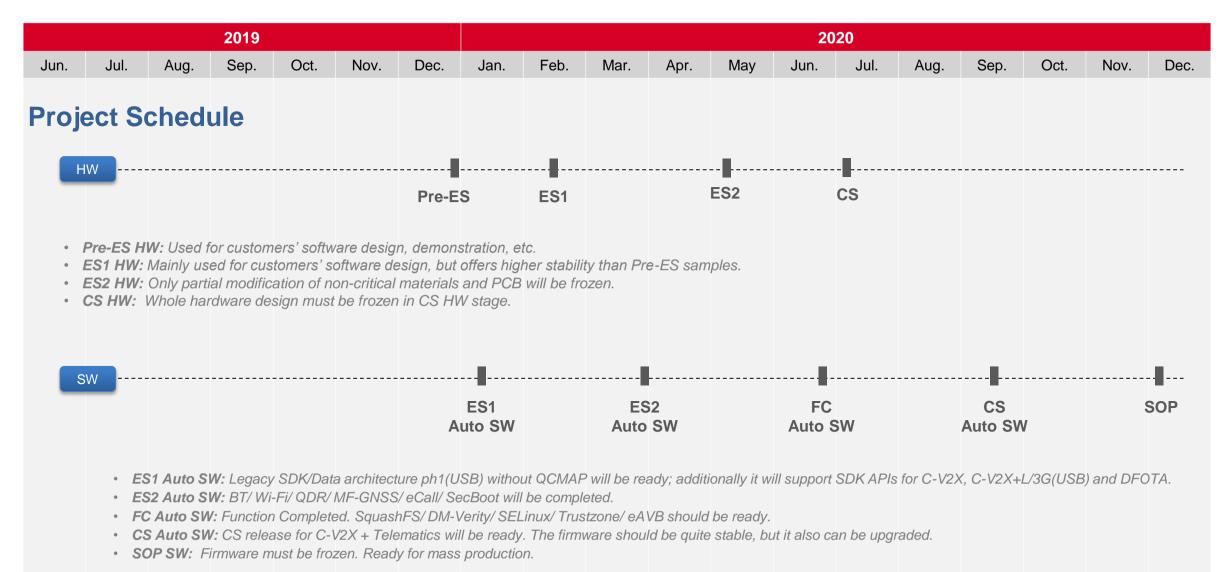
#### AG520R-NA Timeline





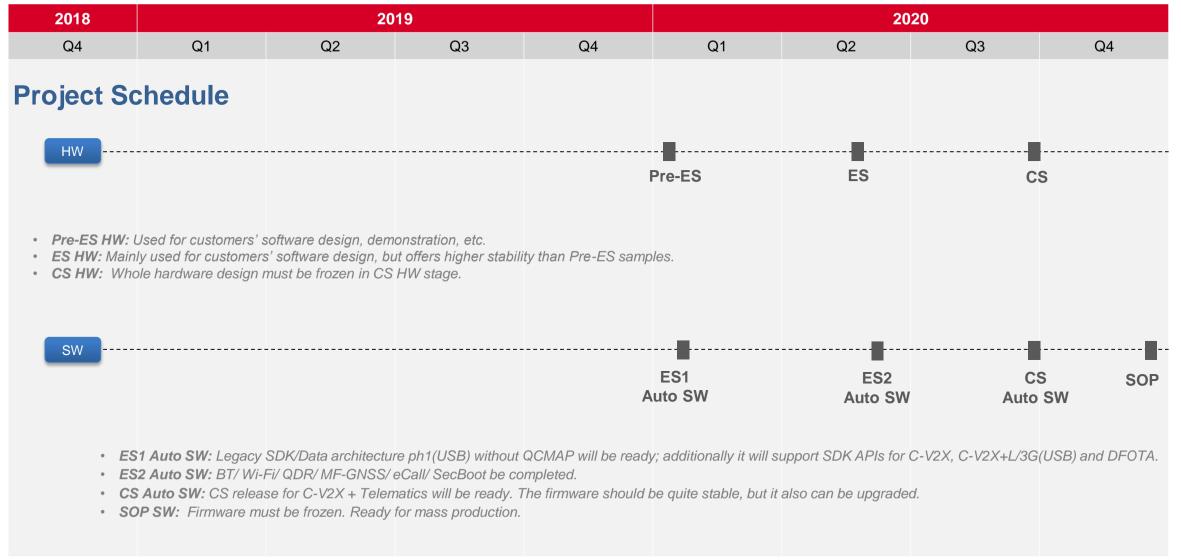
#### AG520R-JP Timeline





## AG520R-LA Timeline (Preliminary)

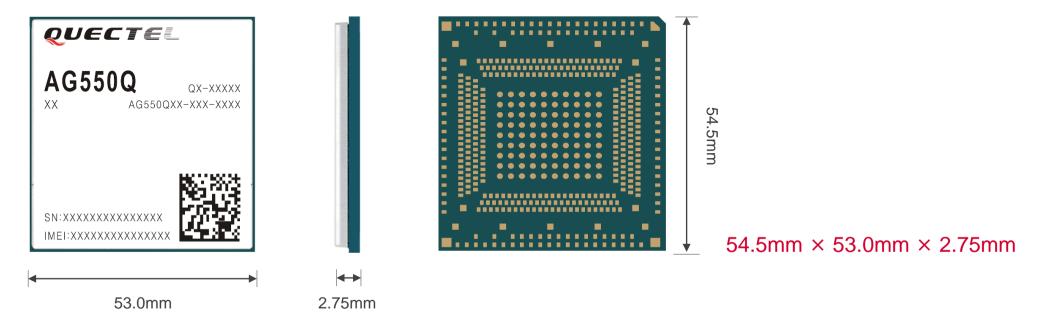




## Automotive Module AG550Q Highlights



Automotive Grade 5G Module + Optional C-V2X/ DSDA (SA515M)



- AEC-Q100 qualified Qualcomm SA515M chipset solution dedicated for automotive 5G NR and optional C-V2X applications
- Ideal for automotive applications with IATF 16949 requirement
- Wide operation temperature range (-40°C to +85°C) and support eCall under +95°C
- Automotive quality processes (PPAP, 8D, DFMEA, PFMEA...)
- Excellent EMC/ESD protection ensures great robustness even in harsh environments
- Compact SMT form factor ideal for integration in slim and size-constrained automotive solutions
- Multi-frequency GNSS receiver available for applications requiring fast and accurate fixes in any environment

## AG550Q Specifications





### **Automotive Grade 5G Module + Optional C-V2X**

54.5mm	X	53.0mm	×	2.75mm
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Maniant		A OFFICE ONLY	A OFFICE FULL	AOFFOO NA*	ACESCO DOW (Discretize)
Variant		AG550Q-CN*	AG550Q-EU*	AG550Q-NA*	AG550Q-ROW (Planning)
5G NR	5G FDD	\	n1/n3/n8/n20/n28	n2/n5/n66/n71	\
30 MK	5G TDD	n41/n78/n79	n78	n41/n78	n77/n78/n79
LTE	FDD-LTE	B1/B3/B5/B7/B8	B1/B3/B5/B7/B8/B20/B28/B32 <sup>①</sup>	B2/B4/B5/B7/B12/B13/B14/B17/B25/ B26/B28/B29 <sup>①</sup> /B30/B66/B71	B1/B3/B5/B7/B8/B11/B18/B19 B20/B21/B26/B32 <sup>①</sup>
	TDD-LTE	B34/B38/B39/B40/B41	B38/B40/B41	B41	B38/B39/B40/B41
LIMTO	WCDMA	B1/B8	B1/B3/B5/B8	B2/B4/B5	B1/B2/B3/B4/B5/B8
UMTS	TD-SCDMA	\	\	\	\
GSM		900/1800MHz	900/1800MHz	\	900/1800/MHz
C-V2X Optional	I	B47	B47	B47	B47
DSDA Optional		LTE	LTE	LTE	LTE
MF-GNSS Op	otional	L1+L2+L5	L1+L2+L5	L1+L2+L5	L1+L2+L5
Dead Recko	oning Optional	QDR 3.0	QDR 3.0	QDR 3.0	QDR 3.0
PPE (RTK)		Optional	Planning	Planning	TBD
Ethernet Option	onal	RGMII	RGMII	RGMII	RGMII
Wi-Fi/BT Inte	erface	Υ	Υ	Υ	Υ
Region		China	EMEA, Korea, Australia, India, Southeast Asia	North America	Latin America, Japan
Certification	1	TBD	TBD  ① LTE-FDD-B29/B32 supports	TBD S Rx Only "Y" means supported.	TBD * means under developme

## AG550Q Key Features



Features	AG550Q
5G NR	3GPP Release 15 NSA/SA operation, Sub-6G
4G Category	LTE Cat 19, 3G/2G fallback
Apps Processor	Cortex A7 at 1.5GHz; 256 KB L2
C-V2X Optional	PC5 Mode 4 (direct communication), uu mode
DSDA Optional	Dual SIM Dual Activation
Embedded GNSS	GPS/ GLONASS/ BeiDou/ Galileo Enhanced Automotive MF-GNSS (L1/L2/L5) Optional
QDR Optional	QDR3 (external IMU required)
Interface	PCIe 3.0, USB 2.0/3.1, RGMII, SDIO, SPI, I2C, I2S, UART, PCM, ADC, (U)SIM, 1PPS, GPIOs
Antenna Interfaces	<ul> <li>4 × 5G/4G antenna interfaces (4×4 MIMO)</li> <li>2 × antenna interfaces for DSDA (2×2 MIMO)</li> <li>2 × C-V2X antenna interfaces (2×2 MIMO)</li> <li>1 × GNSS antenna interface</li> </ul>
	5G NR: Max 1.77 Gbps (DL), Max 490 Mbps (UL)
	LTE: LTE-FDD: Max 1.6 Gbps (DL), Max 150 Mbps (UL) LTE-TDD: Max 1.16 Gbps (DL), Max 45 Mbps (UL)
Data Speed	UMTS: DC-HSDPA: Max 42 Mbps HSUPA: Max 5.76 Mbps WCDMA: Max 384Kbps (DL/UL)
Data Opecu	TD-SCDMA: Max 4.2 Mbps (DL), Max 2.2 Mbps (UL)
	<b>GSM:</b> EDGE: Max 296Kbps (DL), Max 236.8Kbps (UL) GPRS: Max 107Kbps (DL), Max 85.6Kbps (UL)
	C-V2X: Tx: Max 48 Mbps, Rx Max 48 Mbps

### AG550Q-CN Timeline



Rev.: V2.6 | Status: Released

	20	19							2021													
Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.
IW								₹		<b>Z</b>		<b>7</b>										
	Pre-ES	3	ES0					ES1	Pre	e-CS	C	S										
	CS HW:					DV testin frozen in			er stabili	ty than E	ES sampl	es. PCB	design fr	ozen.	<b>V</b>							
ingle	SIM	re-ES1	Pre	-ES2			ES1	ES2	ES3	(	CS			S	OP							
G+C-									<b></b>					<b>Z</b>							7	
+DSI	JA								ES1		ES2		_	S3			FC			C		

- Pre-ES2: Basic data call 4G, SMS, voice call, NW, peripheral interface, basic RGMII, AB, AT, SIM, LAN, DM, audio will be ready.
- ES1: 5G NSA TDD n78/n41;4G, 5G and Sub-6G NSA TDD data call over USB; Tethered data call over USB/ETH (QCMAP architecture); Telematics SDK support for basic data call; OTA stationary data call support in CMMCC/CT/CU:
- ES2: Hastings Support; Emac upstream drivers; Location: L1,L5: MF-GNSS,QDR;
- ES3: QWES (Qualcomm Wireless Edge services); 5G Mobility support in CMCC/CU/CT;
- CS: China certification, field stability fixes; Single SIM CS release for Telematics will be ready. It is quite stable, but it can be upgraded.
- **SOP:** Final fixes, it must be frozen.

#### \*\*\* 5G+C-V2X+DSDA \*\*\*

- ES1: Low-power, MF-GNSS L1+L5 with TelSDK, 5G SA on FDD initial support, thermal mitigation, DCVS. FTM and RF calibration for C-V2X
- ES2: Standalone C-V2X, C-V2X TelSDK supported on SA2150P, PACE/TUNC initial support, DSDA L+G (No C-V2X) with TelSDK support, SA2150P CV2X RGMII
- ES3: C-V2X with concurrent WWAN on SA515M (Single SIM), DSDA L+L / W+L / 5G+L / 5G+G with Tel SDK supported on A7
- FC (Function Complete): 5G NSA/SA, C-V2X fixes, DSDA 5G+L / 5G+G / L+L, Commercialization fixes
- CS: CS release for Telematics, C-V2X and DSDA will be ready. It is quite stable, but it can be upgraded.
- SOP: Firmware must be frozen.

## AG550Q-EU Timeline (Preliminary)



						\			,	/											
2	2019							202	20									2021			
. Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul
N	$\blacksquare$			•				$\blacksquare$				7									
V	Pre-ES			ES	0			ES1			C	S									
ESO/ES	S HW: Use S1 HW: M V: Whole	lainly use	ed for cus	stomers'	software	design,	but offer:		tability t	han Pre-	ES samp	les.									
5G ngle SIM			l	Pre-ES			ES1	ES	2	<u>\</u>	FC		C	S			SC	)P			
G+C-V2X												<b>V</b>		<b>V</b>							<b>7</b> 
+DSDA									ES1			ES2	- 1	ES3			FC			CS	5 5
5G Sing	ile SIM ***	•																			
	3: Basic d									4 <i>B, AT,</i> S	SIM, LAN	DM, aud	dio will b	e ready.							
	Backup & I										· (: DO	1/0									
	Low-power Inction Co								rt, tnern	nai mitiga	ation, DC	VS									
	ingle SIM					, ,			it can be	e uparad	ed										

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- FC (Function Complete): 5G NSA/SA, C-V2X fixes, DSDA 5G+L / 5G+G / L+L, Commercialization fixes
- CS: CS release for Telematics, C-V2X and DSDA will be ready. It is quite stable, but it can be upgraded.
- **SOP**: Firmware must be frozen.

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• **SOP:** Firmware must be frozen.

## AG550Q-NA Timeline (Preliminary)



Rev.: V2.6 | Status: Released

							`			<i>J</i> /												
201	9						20	020										2021				
Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Se
łW	<b>V</b>							<b>V</b>				<b>7</b>										
	Pre-ES			ESC	)			ES1			C	S										
• E	ESO/ES1	<b>HW:</b> M	lainly use	stomers' ed for cus e design	stomers'	software	design,	but offer	etc. rs higher :	stability t	han Pre-	-ES samp	oles.									
5G single S	IM			Pre-ES			ES1	E	. <b>V</b> S2	 I	-C		\	S			SC	/ )P				
5G+C-V +DSD										<b></b>		<b></b>					<b></b>			<b></b>		<b>7</b>
+030	A									ES1		ES2		ES3			FC			CS	S	OP
** 5G S	ingle Sl	IM ***																				
<ul><li> ES1</li><li> ES2</li><li> FC (</li><li> CS:</li></ul>	1: Backi 2: Low- <sub>l</sub> (Function : Single	up & res power, N <b>on Com</b> SIM CS	store, RG MF-GNS plete):	GMII, C-V S L1+L5 5G SA or for Teler	2X RF ca with Tels n FDD, T	alibration SDK, 5G TeISDK si	, 5G NS. SA on F upport o	A fixes, T DD initia n SA215	basic RC TelSDK, e Il support, IOP ble, but it	eCall thermal	mitigatio	on, DCVS		will be I	ready.							
** 5G+0	C-V2X+I	DSDA *	**																			
<ul><li> ES1</li><li> ES2</li><li> ES3</li></ul>	1: Low-p 2: Stand 3: C-V2.	ower, N dalone C X with c	MF-GNSS C-V2X, Concurrer	C-V2X Tel nt WWAN	SDK sup I on SA5	pported of 15M (Sin	n SA215 gle SIM,	50P, PAC ), DSDA	Support, CE/TUNC L+L / W+	initial su L / 5G+L	pport, D /5G+G	SDA L+G with Tel	(No C-V	/2X) with	n TelSDK			P CV2X	RGMII			

- FC (Function Complete): 5G NSA/SA, C-V2X fixes, DSDA 5G+L / 5G+G / L+L, Commercialization fixes
- CS: CS release for Telematics, C-V2X and DSDA will be ready. It is quite stable, but it can be upgraded.
- **SOP:** Firmware must be frozen.

## AG550Q-ROW Timeline (Preliminary)

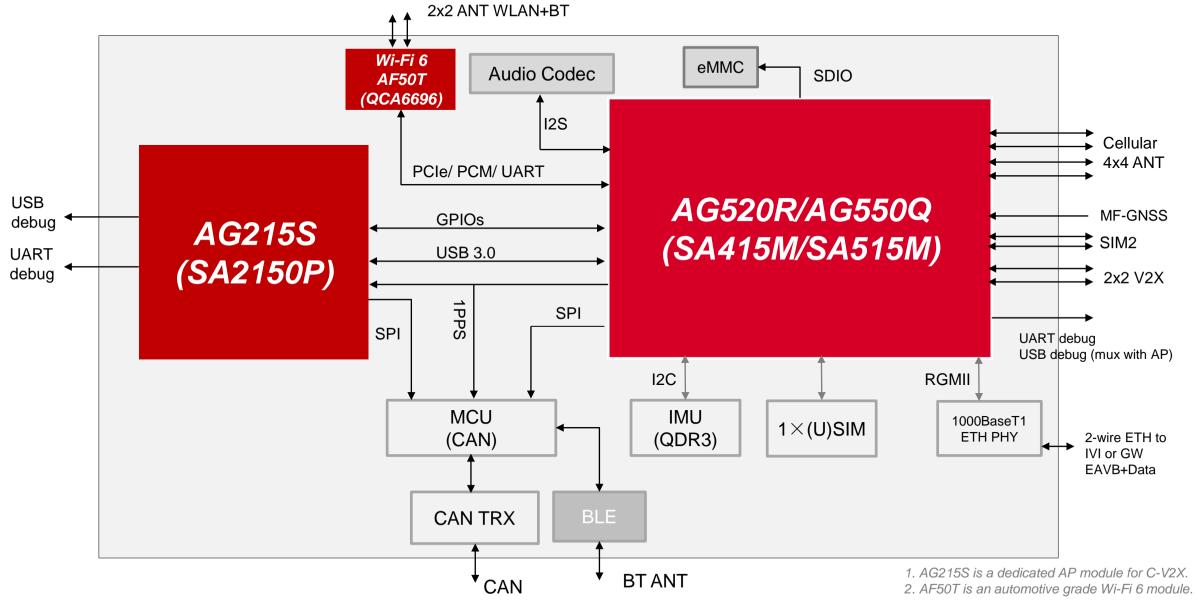
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2019						20	20										2021				
Dec.	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.	Jan.	Feb.	Mar.	Apr.	May	Jun.	Jul.	Aug.	Sep.
HW	▼			<b>V</b>				<b>Y</b>													
	Pre-ES			ES	0			ES1			CS										
• ESO/E • CS HV	S HW: Use S1 HW: M W: Whole	ainly use	d for cus	tomers' s	software	design, k	out offers		stability t	than Pre	-ES samp	les.									
5G Single SIM	J			Pre-ES			<b>▼</b>		<b>V</b>		FC			<b>V</b>				, 			
			,	7re-E3			LJI		ES2		FC		,	CS			SO	Р			
5G+C-V2X												<b></b>		<b>V</b>							<b>y</b>
+DSDA *** <b>5G Sing</b>										ES1		ES2		ES3			FC			CS	SOP
<ul><li>Pre-E3</li><li>ES1:</li><li>ES2:</li><li>FC (Fig. CS: S)</li></ul>	S: Basic d Backup & Low-powe unction Co Single SIM Firmware	ata call 4 restore, F r, MF-GN <b>omplete)</b> CS relea	RGMII, C NSS L1+L S 5G SA se for Te	-V2X RF -5 with To on FDD,	calibrati elSDK, 5 TelSDF	ion, 5G N 5G SA on (support	ISA fixes FDD in on SA2	s, TeISD itial supp 150P	K, eCall port, therr	mal mitig	ation, DC		lio will b	e ready.							
*** 5G+C-\	/2X+DSDA	***																			
<ul><li>ES2:</li><li>ES3:</li><li>FC (Ft)</li><li>CS: C</li></ul>	Low-power Standalon C-V2X with unction Co S release the Firmware I	e C-V2X, h concurr omplete) for Telem	C-V2X rent WW. 5G NS. natics, C-	TeISDK s AN on SA A/SA, C-1	upporte 4515M ( V2X fixe	d on SA2 Single SI s, DSDA	150P, P M), DSE 5G+L / (	ACE/TU A L+L / 5G+G / L	JNC initia W+L / 50 L+L, Com	l suppor G+L / 5G nmerciali	t, DSDA L +G with T zation fixe	+G (No C el SDK su es	2-V2X) v	vith TelS			150P CV2	2X RGMI	I		

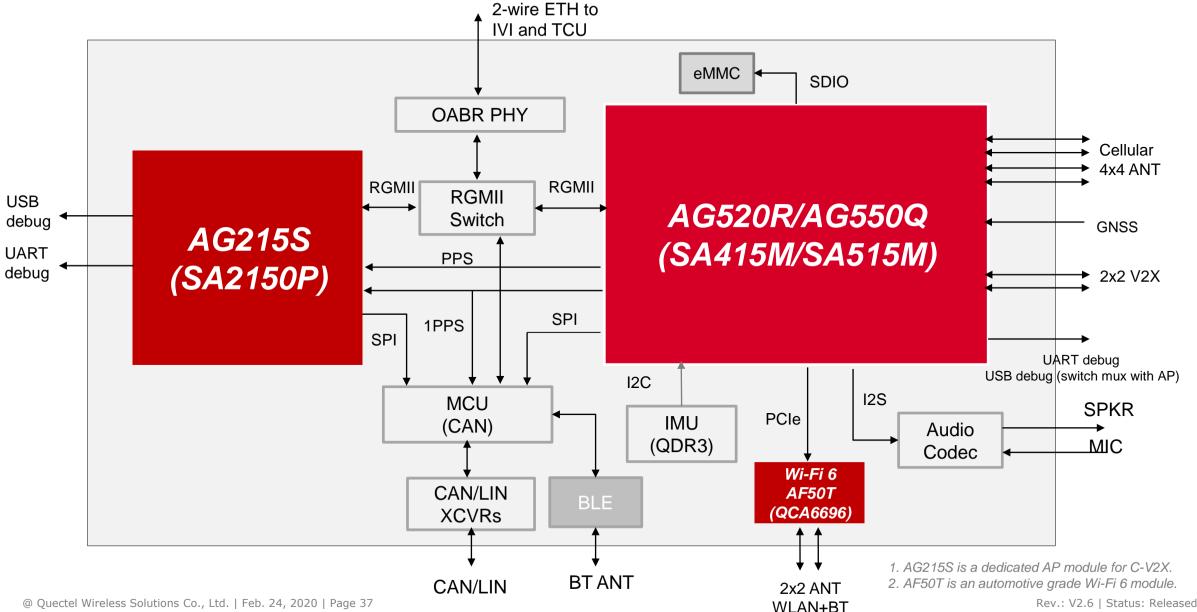
## AG520R/AG550Q Application Architecture (1)





## AG520R/AG550Q Application Architecture (1)



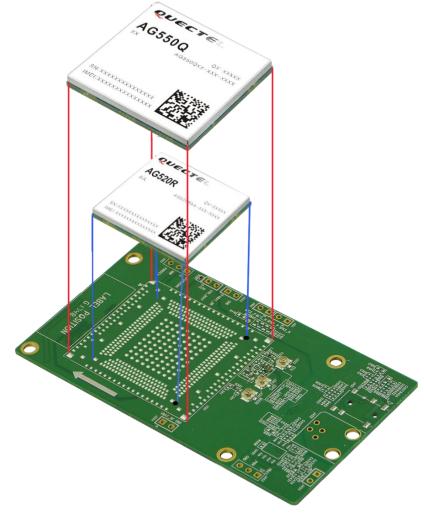


## AG550Q & AG520R Layout Compatibility



Compatible design accommodates

AG550Q and AG520R modules on the same PCB footprint.



The compatibility diagram shown above is for illustration purpose only.

The actual label design may be different.

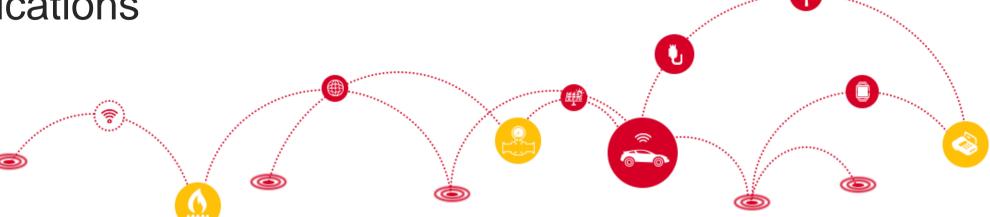


Roadmap
Product Overview

## **C-V2X Introduction**

**Enhanced Technologies** 

Applications

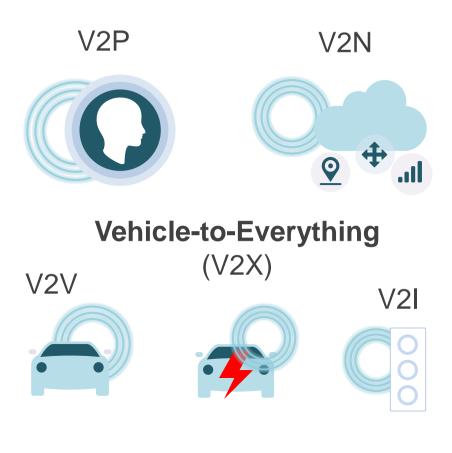


## New Technology - LTE-V2X



#### **LTE-V2X for Future Autonomous Driving**





V2X Communication Technology

## Continuous V2X Technology Evolution



- Careful spectrum planning to support continuous V2X technology evolution shown as below
- Evolution to 5G, while maintaining good backward compatibility

**Basic Safety:**802.11p or C-V2X R14
Established foundation for V2X

Enhanced Safety: C-V2X R14/15 Enhanced range and reliability **Advanced Safety:** 

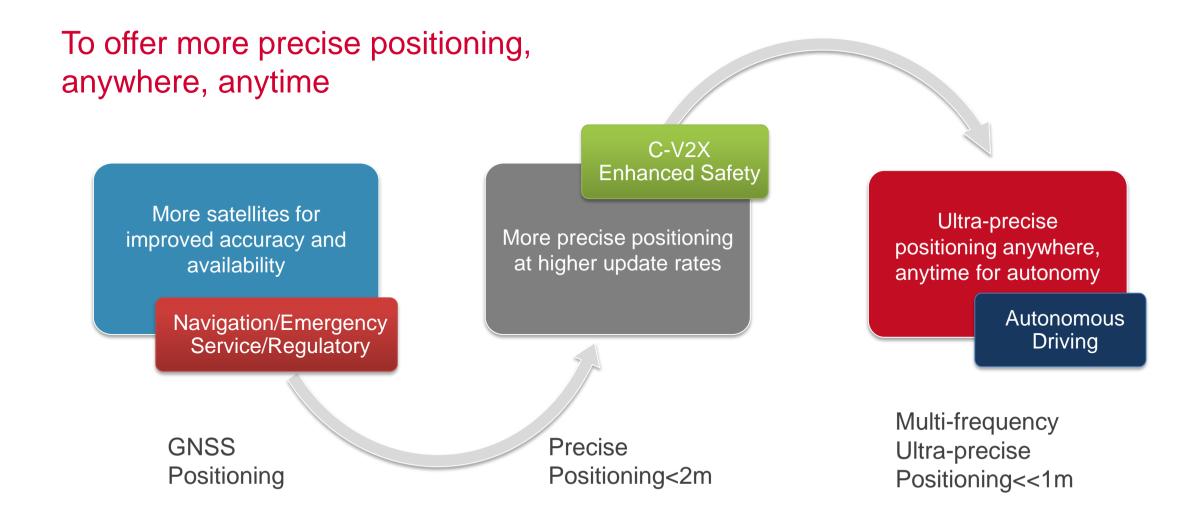
C-V2X R16
Higher throughout
Higher reliability
Wideband ranging and positioning
Lower latency

C-V2X is a critical component for safer autonomous driving, communicating intent and sensor data even in challenging real world conditions.

- Non line-of-sight sensing
- Conveying intent
- Situational awareness

## **Evolving Positioning Technologies for C-V2X**





## C-V2X's Key Advantages in Multiple Dimensions



Enhanced communication range and reliability





Reuse of DSRC/C-ITS higher layers

High density support



R

Leverage of cellular ecosystem

Self managed for reduced cost and complexity



**5G** 

Strong evolution path towards 5G

Synergistic with telematics platform





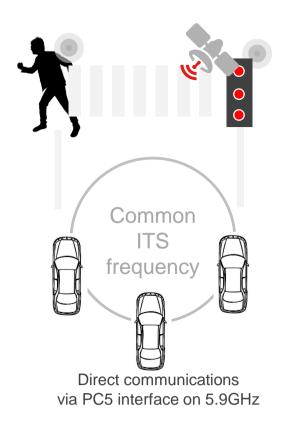
High speed support

## C-V2X Supports Direct Communications

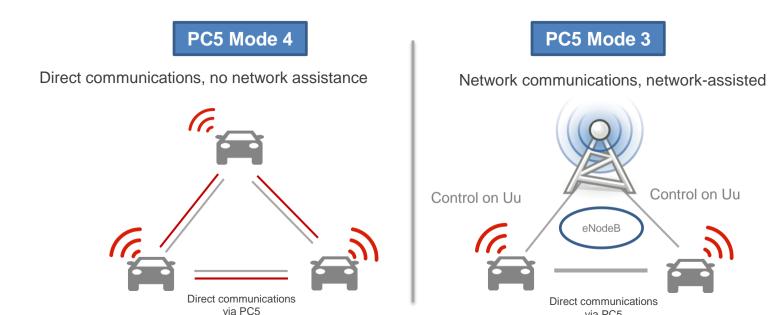


V2X/V2I/V2P direct communications can be self managed

PC5 Interface Mode 4: Self Managed (without cellular network assistance)



- **USIM-less** operation
- Autonomous resource selection
- **GNSS** time synchronization



#### **Reduced Cost**

Does not use prime licensed spectrum for control, no additional network investment

#### **Increased Reliability**

Does not rely on network coverage, does not suffer from service interruption during handover

#### **Reduced Complexity**

Control on Uu

PC5 Mode 3

eNodeB

Direct communications

via PC5

Does not rely on coordination between operators for resource assignment, does not require subscription



Roadmap

**Product Overview** 

C-V2X Introduction

## **Enhanced Technologies**

Applications

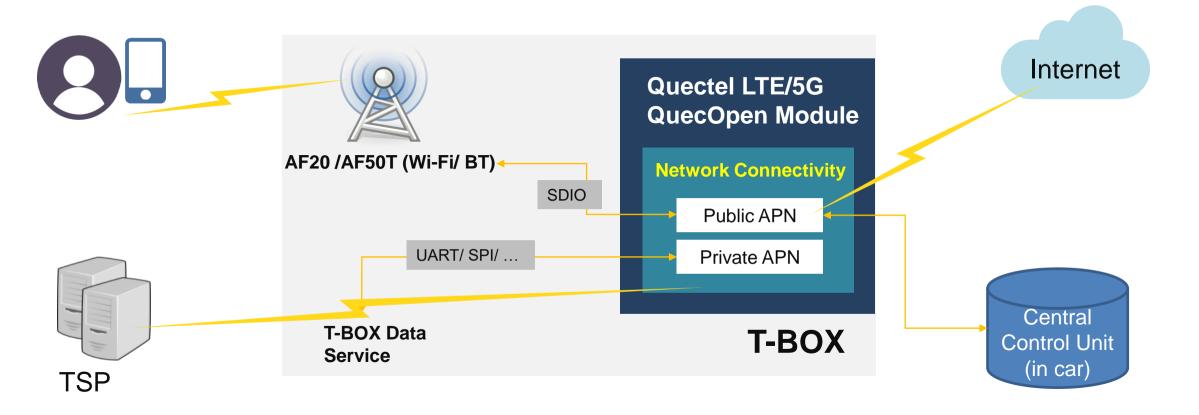
### On-board Technical Characteristics





### Multi-APN Solution





- Users can get in-car infotainment and Wi-Fi access via the public APN.
- TSP is able to communicate with vehicles via the private APN, which can ensure the data that car OEM gets safer and more reliable.
- Maximally 8 APNs are supported now.

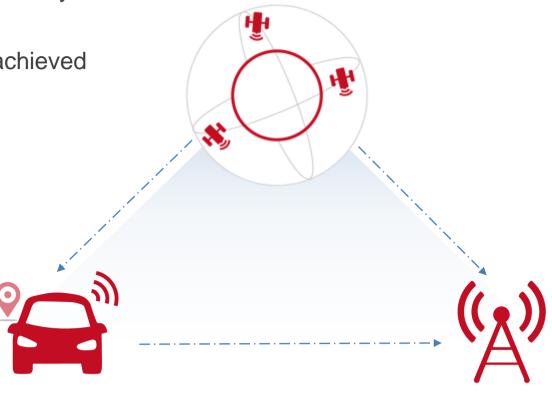
## Multi-Frequency GNSS



By simultaneously tracking all global navigation satellite systems (GNSS) and receiving **two frequencies** from each satellite system to meet car-level positioning accuracy.

Precise positioning and fast convergence time can be achieved globally.

- Multipath signals L1/L5
- Higher chipping rate
- Direct measurement of the lonospheric delay
- Increased robustness
- Integer resolution for PPP



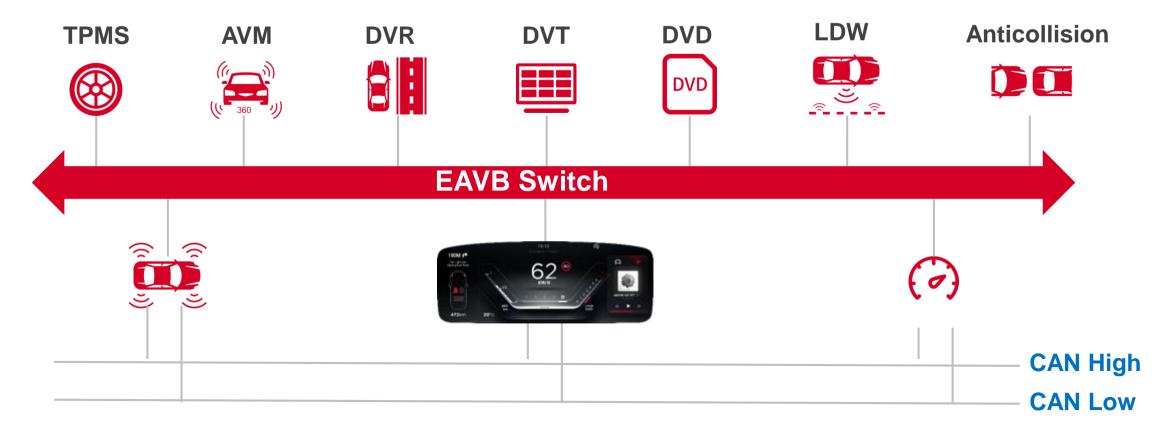
### Estimated Multi-GNSS Performance



SN.	GNSS Performance Metric	L1 GNSS	L1+L5 GNSS	Remark
1	2D positioning error (50%, 68%, 95%)	<2m, <2.5m, <5m	<1.2m, <1.5m, <3m	Under open sky conditions, standalone
2	Altitude accuracy (50%, 68%, 95%)	<2.5m, <3m, <6m	<2m, <2.5m, <5m	
3	The 2D positioning error in meters (50%, 68%, 95%)	<1m, <1.5m, <3m	<0.9m, <1.1m, <2.2m	Under open sky conditions, standalone with SBAS
4	Altitude accuracy (50%, 68%, 95%)	<2m, <2.5m, <5m	<1.6m, <2m, <4m	Under open sky conditions, SBAS
5	Speed accuracy (68%, 95%)	0.15m/s, 0.3m/s	0.15m/s, 0.3m/s	Straight line driving at 30m/s
6	Heading accuracy (68%, 95%)	0.2deg, 0.5deg	0.2deg, 0.5deg	
7	Vertical speed accuracy (68%, 95%)	0.23m/s, 0.45m/s	0.23m/s, 0.45m/s	
8	RTK 2D positioning error in centimeters (50%, 68%, 95%)	<1cm, <1.2cm, <2.5cm	<1cm, <1.2cm, <2.5cm	Open sky, static environment.  Based on Qualcomm GNSS receiver capabilities assuming <1 km short base line RTK, choke ring type precision navigation grade antenna in perfect no interference environment.
9	RTK altitude accuracy (50%, 68%, 95%)	<2cm, <2.5cm, <5cm	<2cm, <2.5cm, <5cm	
10	RTK Heading Accuracy(68%, 95%)	0.05deg, 0.1deg	0.05deg, 0.1deg	

## Ethernet AVB (Audio Video Bridging)

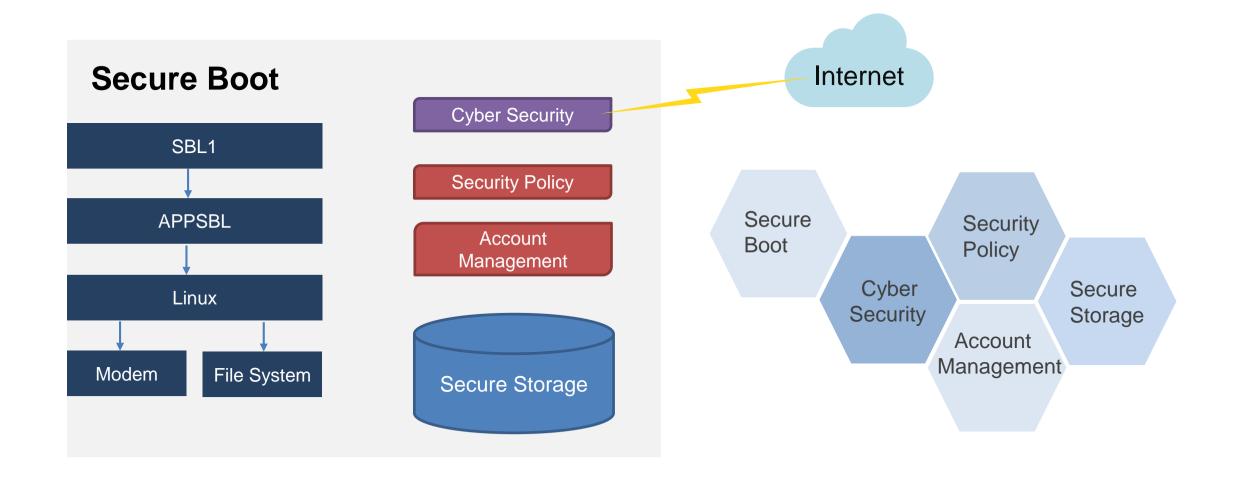




Ethernet AVB (Ethernet Audio/Video Bridging), based on IEEE 802 standard, provides perfect quality of service through guaranteeing bandwidth, limiting latency and accurate time synchronization on the basis of traditional Ethernet network, so as to support various audio and video network multimedia applications.

## **Security Solution**





## QuecOpen® Software Architecture



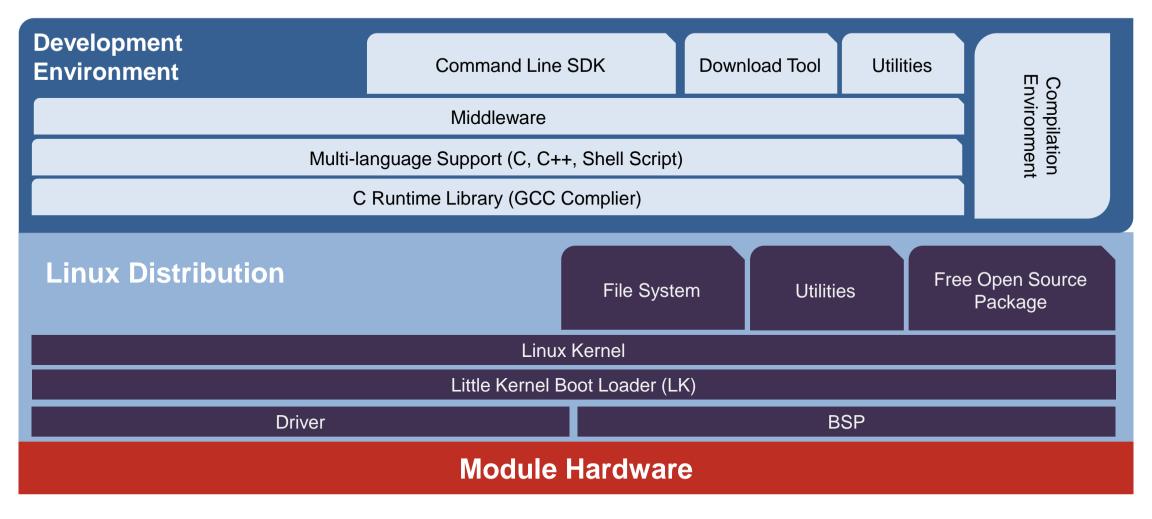


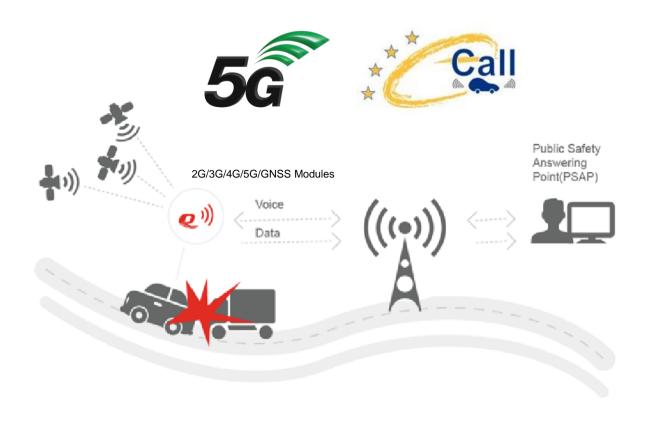
Figure: Framework of QuecOpen®

### eCall



#### eCall Function

A car will have an electronic safety system automatically call emergency services in case of a serious accident. Even if the driver is unconscious, the system will inform rescue workers of the crash site's exact whereabouts, and the rescues will be on its way within minutes. The system is named as "eCall".



- Quectel supports eCall in 2G/3G/4G/5G/GNSS modules and has been working on eCall since late 2011.
- Quectel has enough development experience on eCall to support and assist customers with eCall application development.

### **DR** Function



#### DR Positioning

#### GNSS Positioning

### Quectel AG35 module supports Qualcomm DR Technology

Support Bosch 6-axis inertial MEMS sensor:

Industrial sensor: BMI160

Automotive sensor: SMI130

Support STMicroelectronics 6-axis gyroscope:

Automotive sensor: ASM330

Support InvenSense 6-axis gyroscope:

Automotive sensor: IAM-20680

Condition	2D DR Position Drift		
	2D position error in distance (50%)	~0.6m @1km	
2D DR position drift	2D position error in distance (95%)	~1m @1km	
(straight road tunnel, Minimum 1km length)	2D position error in distance as % of distance travelled (50%)	< 0.6%	
	2D position error in distance as % of distance travelled (95%)	< 1%	

#### Multi-level Building



Underground Parking Lot



DR: Dead Reckoning

## RTK Positioning Technology



Integrating Qualcomm DR technology and Qianxun RTK positioning technique, **Quectel AG35 module** gets <1m positioning accuracy.

#### Qianxun RTK Advantages:











High efficiency

High positioning accuracy and no error accumulation

All-day operation

Automation and high integration level

Item	Accuracy	Definition			
Fixed Solutions					
Horizontal Positioning Accuracy	< 10cm	2D position accuracy of ambiguity-fixed solutions (CEP95)			
Float Solutions					
Horizontal Positioning Accuracy	< 100cm	2D position accuracy of ambiguity float solutions (CEP95)			



RTK: Real-Time Kinematic



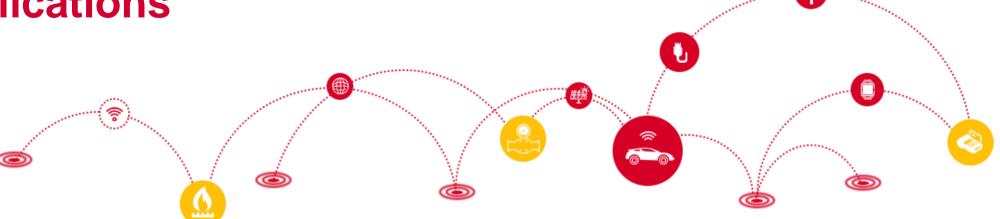
Roadmap

**Product Overview** 

C-V2X Introduction

**Enhanced Technologies** 

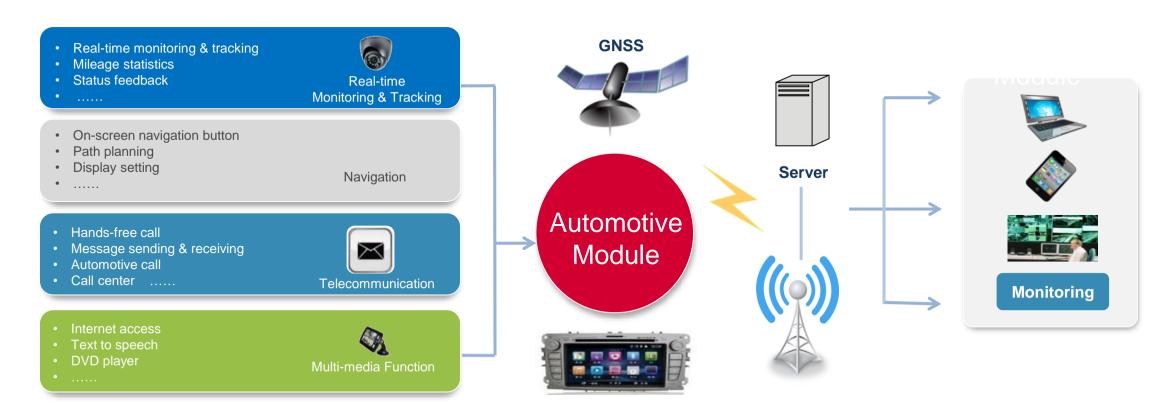




## **GNSS-based Autonomous Navigation System**



- GNSS-based autonomous navigation system + monitoring center + wireless communication + Internet
- Based on M2M module, it combines geographical information system with automotive voice-assisted navigation technology to implement the perfect integration of the on-board wireless communication with autonomous navigation system.



#### T-BOX





T-Box is a standard terminal for the connected car, providing diversified online applications like vehicle remote monitoring, remote control, safety monitoring and alarming, and remote diagnosis by means of 4G/5G remote wireless communication, GNSS satellite positioning, acceleration sensing and CAN communication functions.

T-BOX transmits the vehicle information and position information to the TSP Center via the built-in module. The TSP Center can track the status of vehicles and provide relevant services accordingly.

- Windows and air conditioner control
- Vehicle health alerts
- Unsafe driving alerts & reports
- Remote automatic vehicle diagnostic



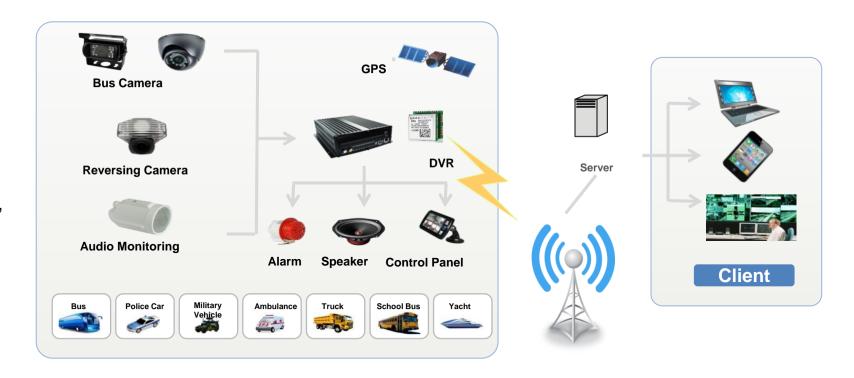


### 4G DVR





- Real-time video and audio monitoring
- Track and record vehicle movement including speed, position, temperature, brake, reverse, turn, alarm, etc.
- Remote communication with driver by intercom, broadcasting, and text message
- Video playback
- Remote alarm



#### **OBD**

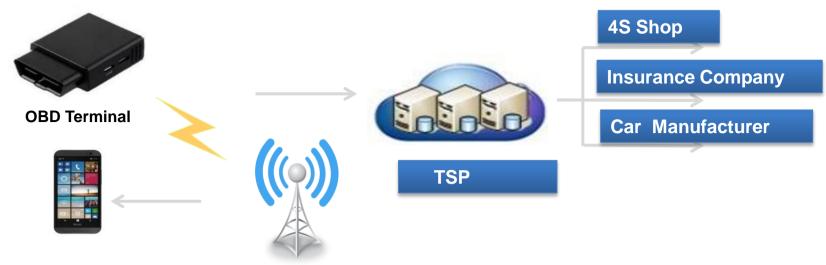




On-board diagnostics (OBD) refers to a vehicle's self-diagnostic and reporting capability.

OBD systems give the vehicle owner or repair technician access to the status of the various vehicle subsystems.

- Self-diagnostic and reporting features
- Integrated GSM/GPRS and/or Bluetooth, GPS+BeiDou.
- Supports CAN and OBD II protocols
- Data can be stored on remote servers
- Provides real-time data for drivers or maintenance technicians to rapidly identify and remedy malfunctions within vehicles





Client

### 4G/5G In-car Wi-Fi





In-car Wi-Fi refers to Internet service provided in a car. Internet access can be provided by tethering a mobile phone, or with a mobile hotspot, whether portable or built into the car.

- Stay connected to everything while on the road
- Access your music, apps, social media everything needed to keep in touch

Fast and reliable connection

Stream movies and TV on the go

#### 4G/5G In-car Wi-Fi



Easy access to multi-media

Real-time data transmission

## Intelligent BOX





Intelligent BOX not only provides the functionalities related with telematics, but also C-V2X functionalities including V2V/ V21/ V2P.

#### Telematics functionalities:

- Windows and air conditioner control
- Obtain real-time traffic, road and pedestrian information
- Vehicle health alerts
- Unsafe driving alerts & reports
- Remote automatic vehicle diagnostic

#### C-V2X functionalities:

V2V/ V2I/ V2P





### **RSU**



- RSU, which literally means Road Side Unit, is installed on the Road Side in traffic light system, ETC systems, etc. and it uses C-V2X technology to communicate with OBU (On Board Unit) inside vehicles.
- When an accident occurs, wireless technologies enable vehicles to share warning messages with other vehicles by using vehicle to vehicle (V2V) communications, and with the emergency services by using vehicle to infrastructure (V2I) communications. Regarding vehicle to infrastructure communications, RSU acts similarly to wireless LAN access points, and can provide communications with the infrastructure.









# Thank you!

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